DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICA

As a below named inventor, I hereby declare that:

My residence and correspondence address, and citizenship, are as stated below, my name and signature.

I believe I am the original, first, and sole inventor (if only one name is below) or joint inventor (if more than one name is below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

ELECTROMAGNETIC NOISE SUPPRESSOR, SEMICONDUCTOR DEVICE USING THE SAME, AND METHOD OF MANUFACTURING THE SAME

the specification of which

is attached hereto	
x was filed on April 4, 2001	and
accorded serial number 09/826,383	
optionally amended on	

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

Priority Claim: I hereby claim priority under 35 U.S.C. § 119, § 120, § 121, and/or §365 as applicable to the following application(s):

Country	Application Number	Date of Filing	Priority Claimed
Japan	101895/2000	April 4, 2000	yes
Japan	340406/2000	November 2, 2000	ves
Japan	342789/2000	November 10, 2000	ves
Japan	342835/2000	November 10, 2000	yes

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorneys to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith, Hopgood, Calimafde, Judlowe & Mondolino, LLP, a firm comprising Roy C. Hopgood, Reg. No. 15,245; John M. Calimafde, Reg. No. 16,895; Stephen B. Judlowe, Reg. No. 21,049; Dennis J. Mondolino, Reg. No. 27,148; James M. Bollinger, Reg. No. 32,555; Brian P. Murphy, Reg. No. 34,986; and Bradley N. Ruben, Reg. No. 32,058.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of eighth joint inven	tor:		
Inventor's Signature:			_ Date:
Correspondence Address:	*****	•	
Residence:			
Citizenship:	 		